OMNIMATE Signal - series BC/SC 3.81
SC-SMT 3.81/09/135G 3.2SN BK BX

Weidmüller Interface GmbH & Co. KG
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www.weidmueller.com

Product image

Similar to illustration

The high-temperature-resistant SC-SMT pin header with 135° wire outlet direction: the 135° angle exists between the plugging direction and the solder pin. The wire outlet direction is then diagonal or 45° to the PCB.

- More freedom when designing components and devices.
- Easy access and a high component density when multiple interfaces are arranged in parallel within a single plugging area
- The housing design is application-friendly because of the additional optional wire outlet direction.
- Available as closed (G) and with solder flange (LF).
- Pin length of either 1.5 mm or 3.2 mm

Weidmüller's 3.81-mm-pitch (0.15 inch) plug-in connectors are compatible with the layouts of standard connectors and offer space for labelling and coding.

General ordering data

Type	SC-SMT 3.81/09/135G 3.2SN BK BX
Order No.	1977700000
Version	PCB plug-in connector, male header, closed side, THT/THR solder connection, 3.81 mm, Number of poles: 9, 135°, Solder pin length (l): 3.2 mm, tinned, black, Box
GTIN (EAN)	4032248685288
Qty.	50 pc(s).
Product data	IEC: 320 V / 17.5 A UL: 300 V / 11 A
Packaging	Box

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Application notes

The solder connection is causing concern among whole global industries and international associations - just a brief outline of the issue would extend far beyond the scope of this summary. Weidmüller is a specialist in electrical connection systems and is always has its finger on the pulse to keep up to date with global development of the latest circuit board technology, manufacturing processes, electrical, chemical and thermal material characteristics and influential factors.
Automatic assembly requirements, the subtleties surrounding paste pressure, temperature profiles in the reflow oven or influential factors on measured results from different quality testing systems are just as important to us as skills such as defining problems in electronics development and finding possible solutions, EMS service providers and the long-term behaviour of a soldered connection under different conditions in daily operation all over the world.
If you should have any questions relating to our products and their behaviour in the soldering process, we will provide you with help and advice on historical challenges such as RoHS legislation and conversion to lead-free operation or on subjects such as whiskers, moisture level, REACH, etc.
The Weidmüller portfolio includes components for through-hole technology (THT) and through-hole reflow procedures (THR) - supplied in a box, tube tray or belt, depending on the process.
Pin geometry, surface systems, pin lengths, constructive parameters and the thermal properties of insulating material are always at the cutting edge of technology. Weidmüller soldering components represent outstanding quality and reliable function. Our own laboratory, electroplating shop and electronics manufacturing plant increase our know-how on a daily basis daily and assure the constant high quality of our products, data and specifications.
The objective for Portfolio and Service and the benefits to you: finding the best solution for every procedure, layout and circuit board - including all the necessary product data and other engineering information for assisting the design-in phase.

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Technical data

Dimensions and weights

Width	35.68 mm	Width (inches)	1.405 inch
Height	14.2 mm	Height (inches)	0.559 inch
Height of lowest version	11 mm	Depth	13.1 mm
Depth (inches)	0.516 inch	Net weight	4.1 g

System specifications

Product family	OMNIMATE Signal - series BC/SC 3.81	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	3.81 mm
Pitch in inches (P)	0.15 inch	Outgoing elbow	135°
Number of poles	9	Number of solder pins per pole	1
Solder pin length (l)	3.2 mm	Solder pin length tolerance	0 / -0,02 mm
Tolerance of solder pin position	± 0.1 mm	Solder pin dimensions	d = 1.0 mm, Octagonal
Solder pin dimensions = d tolerance	0 / -0,03 mm	Solder eyelet hole diameter (D)	1.3 mm
Solder eyelet hole diameter tolerance (D)	+ 0,1 mm	Outside diameter of solder pad	2.1 mm
Template aperture diameter	1.9 mm	L1 in mm	30.48 mm
L1 in inches	1.2 inch	Number of rows	1
Pin series quantity	1	Touch-safe protection acc. to DIN VDE 57 106	Safe from finger touch
Touch-safe protection acc. to DIN VDE 0470	IP 20	Volume resistance	≤ 5mΩ
Can be coded	Yes	Plugging cycles	25

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIa
Comparative Tracking Index (CTI)	≥ 175	Insulation strength	≥ 10^8 Ω
Moisture Level (MSL)	1	UL 94 flammability rating	V-0
GWIT	930 °C	GWFI	960 °C
Contact material	Copper alloy	Contact surface	tinned
Storage temperature, min.	-25 °C	Storage temperature, max.	50 °C
Max. relative humidity during storage	70 %	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-25 °C
Temperature range, installation, max.	120 °C		

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	17.5 A
Rated current, max. number of poles (Tu=20°C)	17.1 A	Rated current, min. number of poles (Tu=40°C)	17.5 A
Rated current, max. number of poles (Tu=40°C)	17.5 A	Rated voltage for surge voltage class / pollution degree II/2	320 V
Rated voltage for surge voltage class / pollution degree III/2	160 V	Rated voltage for surge voltage class / pollution degree III/3	160 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	2.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	2.5 kV	Short-time withstand current resistance	3 x 1s with 76 A

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Technical data

Rated data acc. to CSA

Institute (CSA)		Certificate No. (CSA)	200039-1121690
Rated voltage (Use group B / CSA)	300 V	Rated current (Use group B / CSA)	11 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

Rated data acc. to UL 1059

Institute (cURus)		Certificate No. (cURus)	E60693
Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group D / UL 1059)	300 V
Rated current (Use group B / UL 1059)	11 A	Rated current (Use group D / UL 1059)	11 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

Packing

Packaging	Box	VPE length	170 mm
VPE width	70 mm	VPE height	42 mm

Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
eClass 9.0	27-44-04-02	eClass 9.1	27-44-04-02
eClass 10.0	27-44-04-02	UNSPSC	30-21-18-10

Notes

Notes	• Rated current related to rated cross-section & min. No. of poles. • Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards. • P on drawing = pitch
IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.

Approvals

Approvals	
ROHS	Conform

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Technical data

Downloads

Approval/Certificate/Document of Conformity	Declaration of the Manufacturer
Brochure/Catalogue	FL DRIVES EN MB SMT EN FL DRIVES DE MB DEVICE MANUF. EN CAT 2 PORTFOLIOGUIDE EN FL BUILDING SAFETY EN FL APPL LED LIGHTING EN FL INDUSTR.CONTROLS EN FL MACHINE SAFETY EN FL HEATING ELECTR EN FL APPL_INVERTER EN FL_BASE_STATION_EN FL ELEVATOR EN FL POWER SUPPLY EN FL 72H SAMPLE SER EN PO OMNIMATE EN
Engineering Data	STEP
White paper surface mount technology	Download Whitepaper

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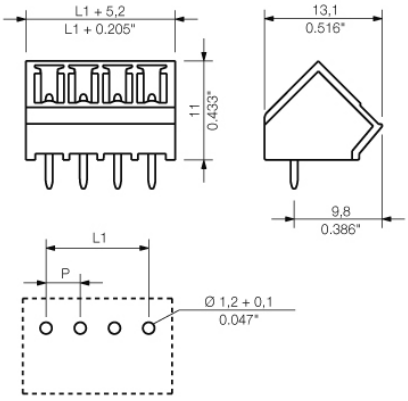
Drawings

Dimensional drawing



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Accessories

Coding elements

Only connects what is supposed to be connected: the right connection at the right place.
Coding elements and locking devices clearly assign connecting elements during the manufacturing process and operation
The coding elements and locking devices are inserted prior to assembly or during the cable assembly phase.
The Weidmüller alternative: configure online using the variant configurator to precode prior to delivery.
Incorrect assembly on the circuit board and incorrect plugging of connecting elements is no longer possible.
The advantage: no troubleshooting during manufacture and no operational errors by the user.

General ordering data

Type	SC-SMT 3.81 KO GY BX	Version	Product data	Packaging
Order No.	1968900000	PCB plug-in connector, Accessories, Coding element, grey, Number of		Box
GTIN (EAN)	4032248772865	poles: 6		
Qty.	100 pc(s).			

Wave Solder Profile

Recommended wave solderding profiles

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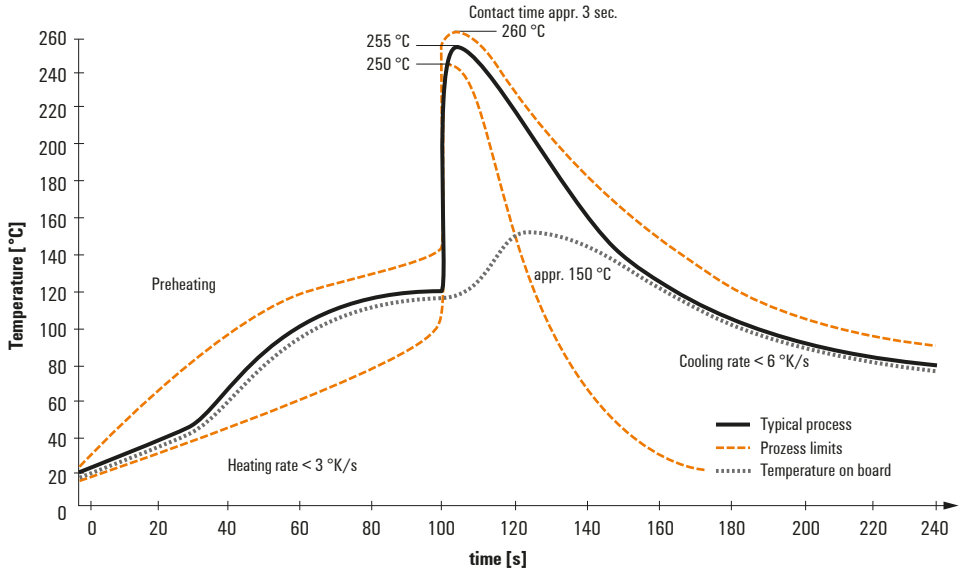
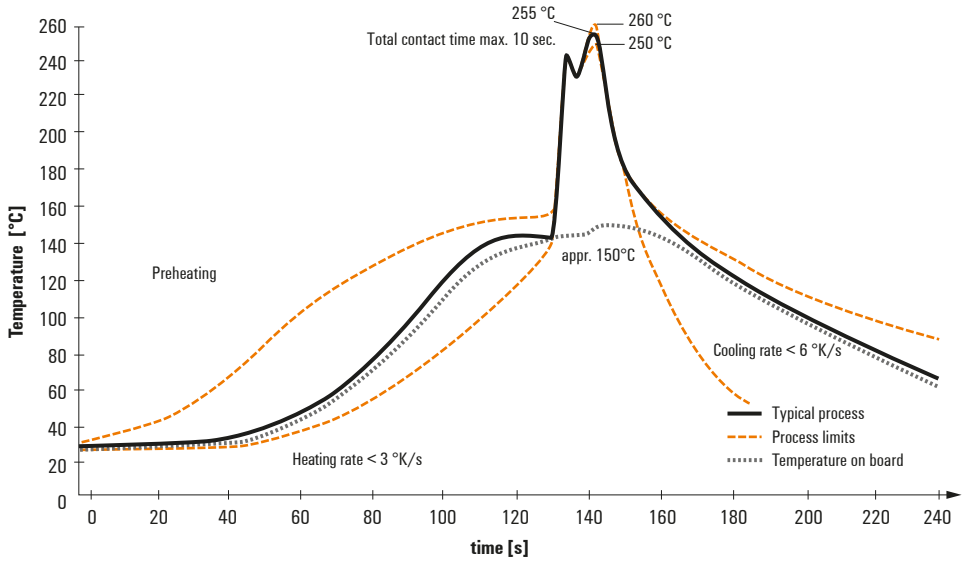
Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:
- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

Reflow Solder Profile

Recommended reflow soldering profile

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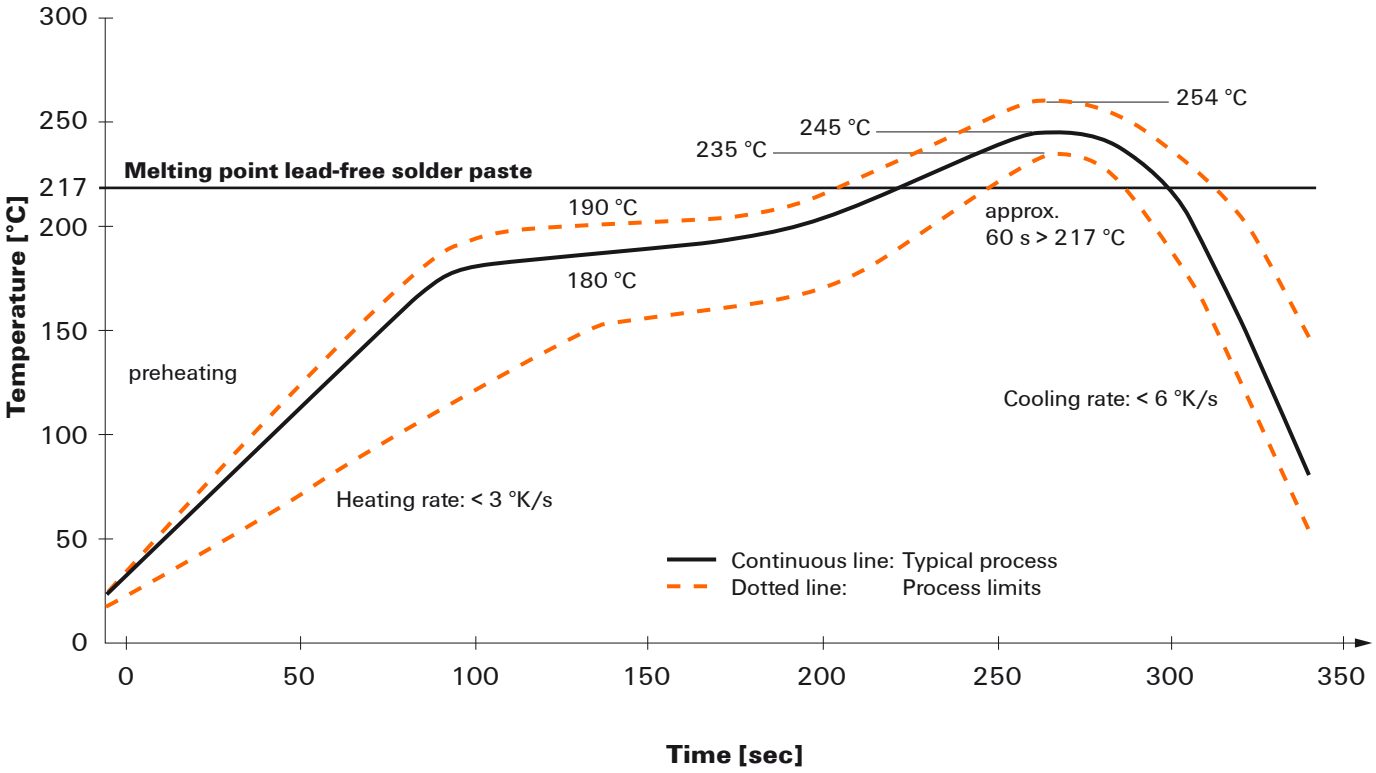

Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:
- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically ≤ +3K/s. In parallel the solder paste is ‚activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at ≥ -6K/s solder is cured. Board and components cool down while avoiding cold cracks.